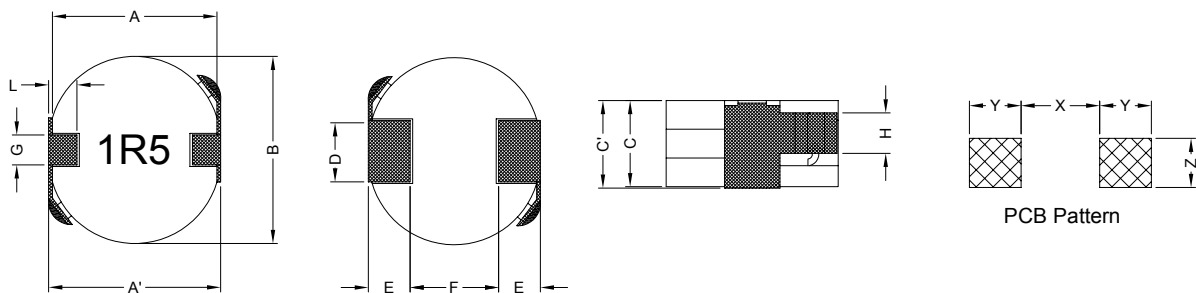


### 1. PART NO. EXPRESSION :

PDC1040C-1R0YF  
 (a) (b) (c) (d) (e)(f)

- (a) Series code
- (b) Dimension code
- (c) Type code
- (d) Inductance code : 1R0 = 1.0uH
- (e) Tolerance code : M = ±20%, Y = ±30%
- (f) F : Lead Free

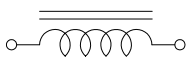
### 2. CONFIGURATION & DIMENSIONS :



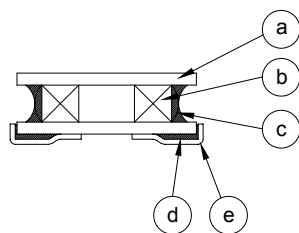
Unit : mm

A	B	C	D	E	F
10.5 Max.	10±0.5	4.0 Max.	3.0±0.2	1.2±0.2	7.7±0.5
G	H	L	X	Y	Z
1.4±0.2	155±0.2	0.7±0.2	7.40 Ref.	1.70 Ref.	3.60 Ref.

### 3. SCHEMATIC :



### 4. MATERIALS :



- (a) Core : Ferrite Core
- (b) Wire : Enamelled Copper Wire
- (c) Adhesive : Epoxy
- (d) Adhesive : Epoxy
- (e) Clip : Tin Clip



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### 5. GENERAL SPECIFICATION :

- a) Test Frequency : 100KHz/0.25Vdc
- b) Ambient Temp. : 20°C
- c) Irms(A) : Will cause coil temperature to rise  $\Delta T \leq 40^\circ\text{C}$
- d) Isat(A) : Will cause  $L_0$  to drop approximately 30%
- e) Operating temp. : -20°C to +105°C ( include self-temp. rise )

### 6. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance ( $\mu\text{H}$ )	DCR ( $\text{m}\Omega$ ) Max.	Irms ( A ) Max.	Isat ( A ) Max.
PDC1040C-1R0YF	1.0 $\pm 30\%$	6.5	10.0	11.0
PDC1040C-1R5YF	1.5 $\pm 30\%$	8.1	9.0	10.0
PDC1040C-2R5YF	2.5 $\pm 30\%$	10.5	7.0	7.5
PDC1040C-3R8YF	3.8 $\pm 30\%$	13.0	5.5	6.0
PDC1040C-4R7YF	4.7 $\pm 30\%$	15.3	5.4	5.6
PDC1040C-5R2YF	5.2 $\pm 30\%$	22.0	5.0	5.5
PDC1040C-7R0YF	7.0 $\pm 30\%$	27.0	4.5	4.8
PDC1040C-100MF	10 $\pm 20\%$	35.0	4.0	4.4
PDC1040C-150MF	15 $\pm 20\%$	50.0	3.2	3.6
PDC1040C-220MF	22 $\pm 20\%$	73.0	2.6	2.9
PDC1040C-330MF	33 $\pm 20\%$	93.0	2.2	2.3



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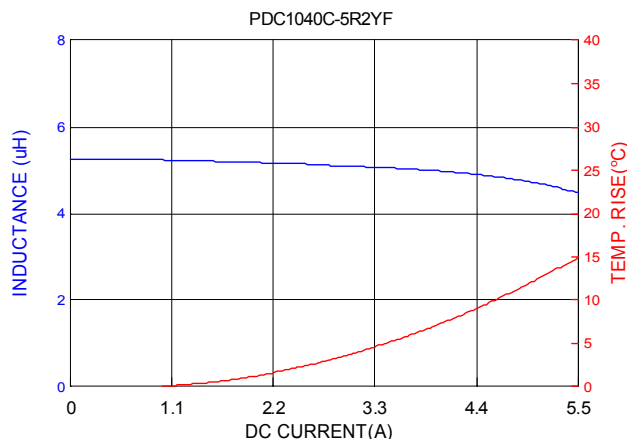
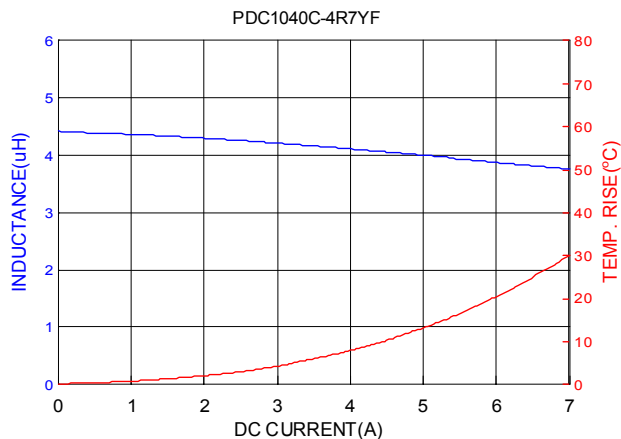
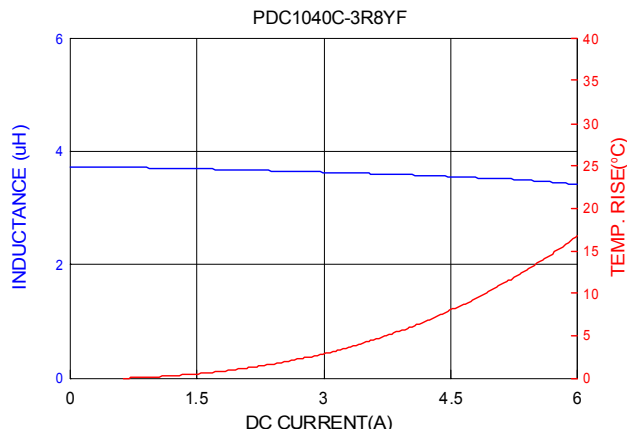
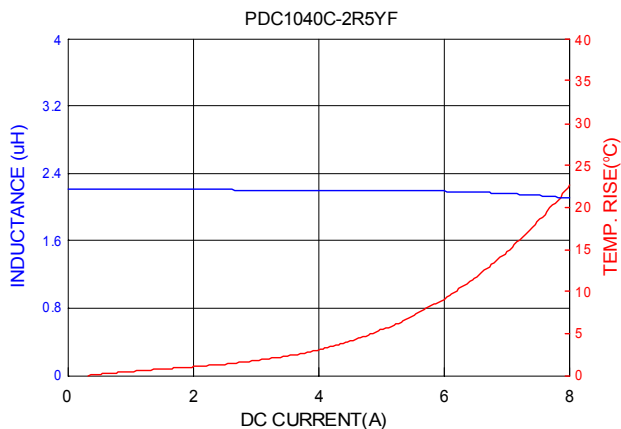
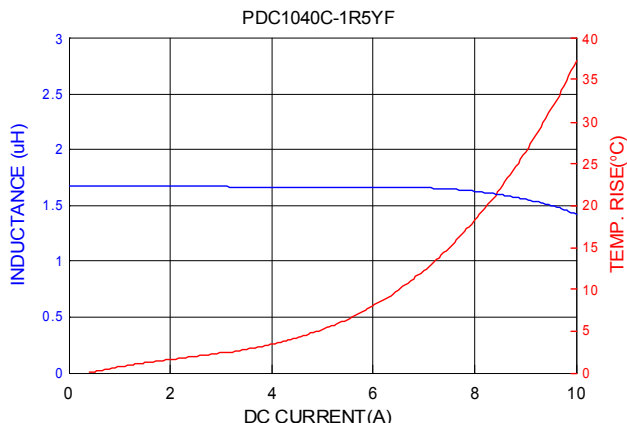
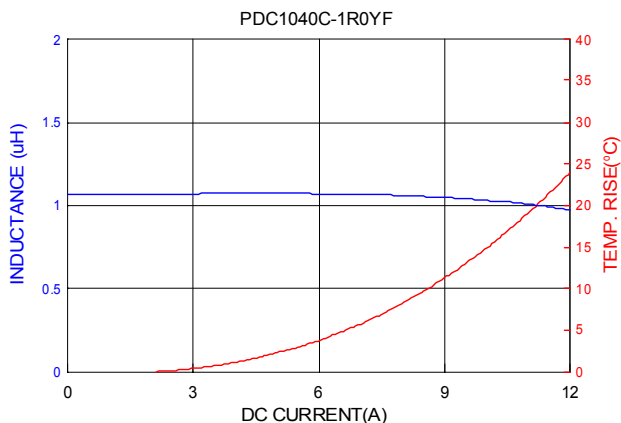
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7. CHARACTERISTICS CURVES :



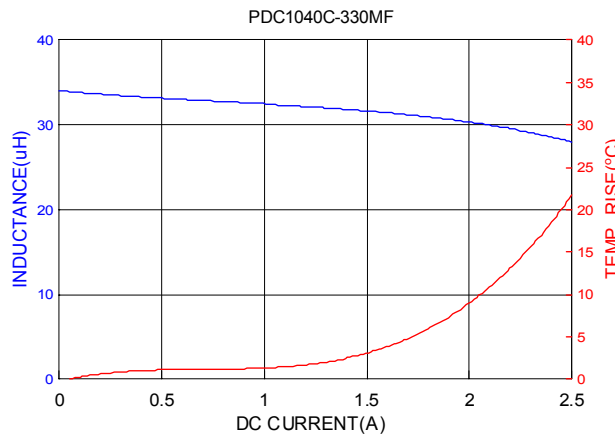
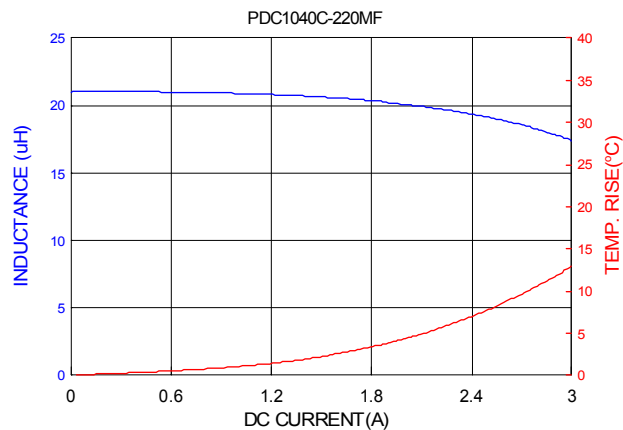
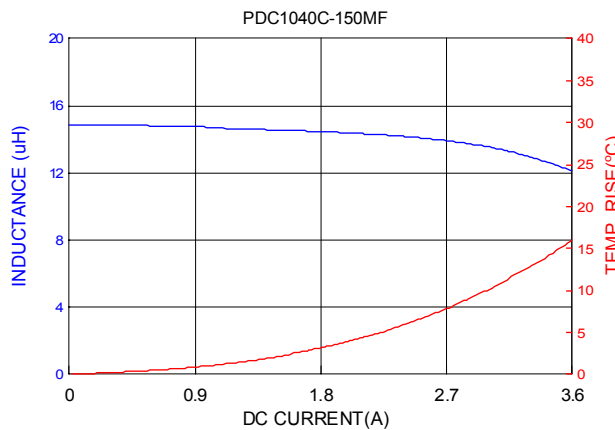
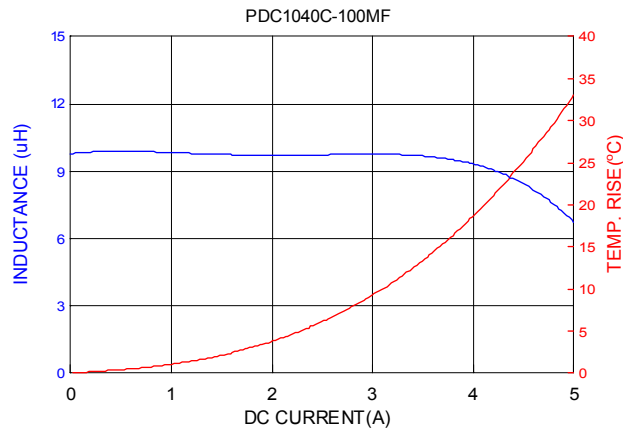
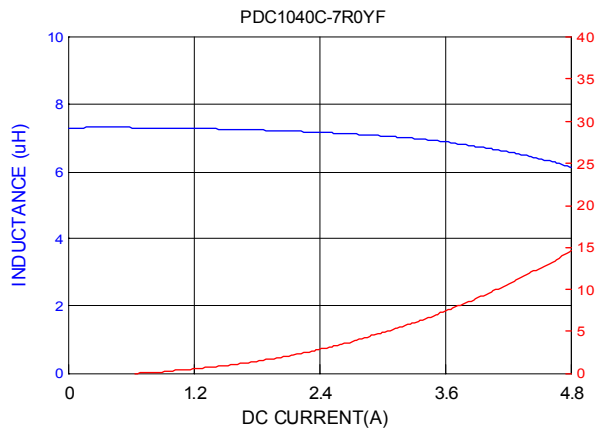
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7. CHARACTERISTICS CURVES :



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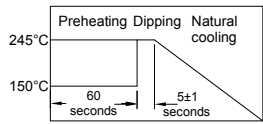
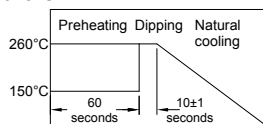
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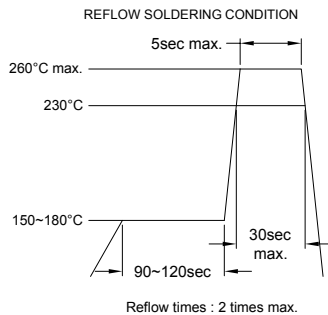
**8. ELECTRICAL CHARACTERISTICS :**

ITEM	JUDGEMENT STANDARD	TEST CONDITION														
Mechanical Performance Test																
Solderability Test	More than 90% of the terminal electrode should be covered with solder.	Preheat : 150°C, 60sec. Solder : lead free (recommend) Solder Temperature : 245±5°C Flux for lead free : rosin Dip Time : 5±1sec. 														
Solder Heat Resistance	1. Appearance : No damage 2. Inductance change : Within ±10% of initial value	Preheat : 150°C Preheat time : 1 min Solder Temperature : 260±5°C Dip Time : 10±1sec.  Measure at room temperature after placing for 24 hrs.														
Reliability Test																
Humidity Resistance	1. Appearance : No damage 2. All electrical and mechanical parameters within tolerance	Temperature : 40±2°C Humidity : 90% to 95% Applied Current : Rated Current Time : 500±12 hours Component should be stabilized at normal condition for 24±2 hours before test.														
High Temperature Life Test	1. Appearance : No damage 2. All electrical and mechanical parameters within tolerance	Temperature : 85±3°C Time : 500+24/-0 hrs Component should be stabilized at normal condition for 24±2 hours before test.														
Low Temperature Life Test		Temperature : -40±3°C Time : 500+24/-0 hrs Component should be stabilized at normal condition for 24±2 hours before test.														
Temperature Cycle (Thermal Shock)		Conditions of 1 cycle. <table border="1" data-bbox="917 1332 1284 1467"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Times (min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-40±3</td> <td>30</td> </tr> <tr> <td>2</td> <td>25±2</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>+85±3</td> <td>30</td> </tr> <tr> <td>4</td> <td>25±2</td> <td>Within 3</td> </tr> </tbody> </table> Total : 10 cycles Component should be stabilized at normal condition for 24±2 hours before test.	Step	Temperature (°C)	Times (min.)	1	-40±3	30	2	25±2	Within 3	3	+85±3	30	4	25±2
Step	Temperature (°C)	Times (min.)														
1	-40±3	30														
2	25±2	Within 3														
3	+85±3	30														
4	25±2	Within 3														
Drop	Drop 10 times on a concrete floor from a height of 1m.	No mechanical damage All electrical and mechanical parameters within tolerance														
Electrical Characteristics Test																
Heat Rated Current (Irms)	Idc(Irms) @ Δ ≤ 45°C a. ΔT is the component surface temperature rise scope in room temperature, the test component surface temperature increase not more than 45°C b. Body should not be damaged	1. Ambient temp : 25°C with inhibitive ventilation condition: 2. Applied Current : DC Current, the current shall be step by step increase to the load component.														
Saturation Current (Isat)	Isat @ L ≥ 70% L0 L : test inductance with DC current L0 : the initial inductance without DC current	1. Ambient temp : 25°C 2. Applied Current : DC Current, the current shall be step by step increase to the load component.														

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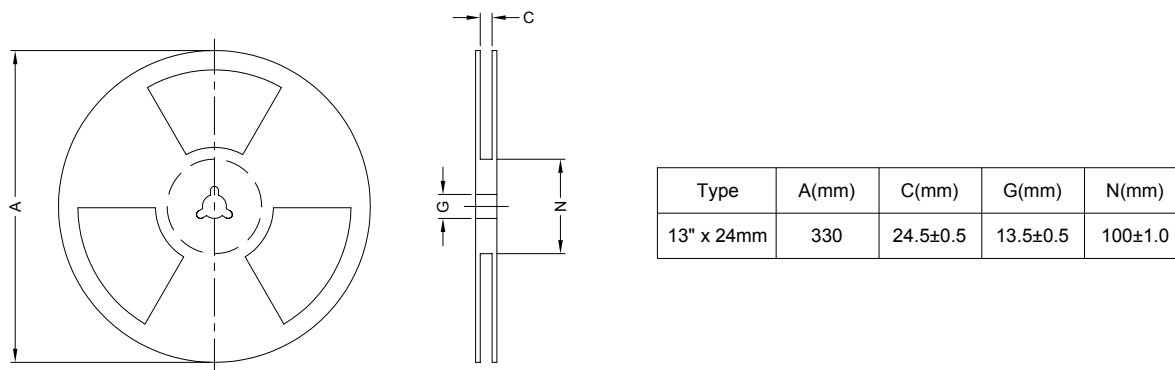
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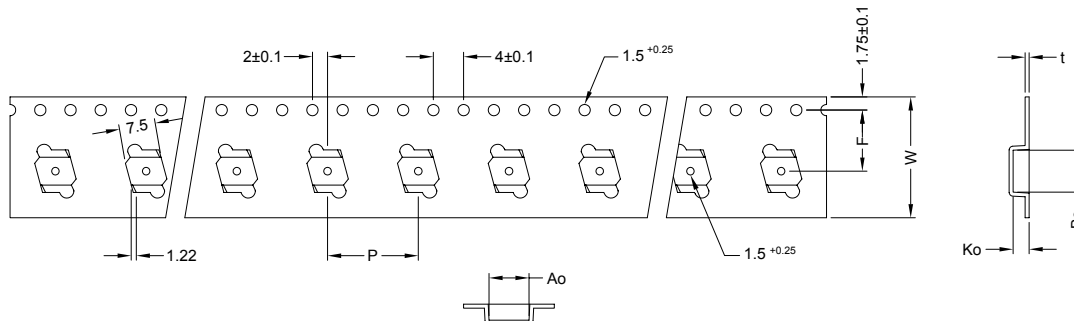


## 9. PACKAGING INFORMATION :

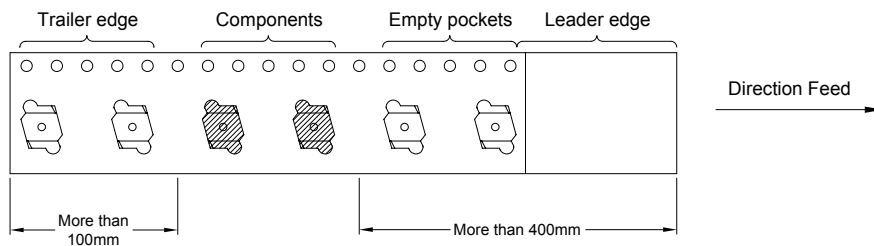
### 9-1. Reel Dimension



### 9-2. Tape Dimension / 12mm



Series	Ao(mm)	Bo(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)
PDC1040C	10.65±0.1	10.65±0.1	4.3±0.1	16.0±0.1	24±0.3	11.5±0.1	0.4±0.05



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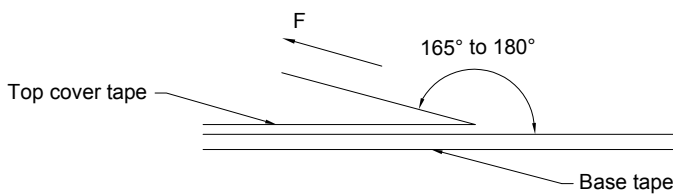


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**9-3. Packaging Quantity**

Size	PDC1040C
Chip / Reel	1000
Inner Box	2000
Carton	8000

**9-4. Tearing Off Force**



The force for tearing off cover tape is 10 to 125 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed (mm/min)
5~35	45~85	860~1060	300

**Application Notice**

1. Storage Conditions :

To maintain the solderability of terminal electrodes :

- a) Temperature and humidity conditions : Less than 40°C and 70% RH.
- b) Recommended products should be used within 6 months from the time of delivery.
- c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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